As an inventor named below or on any attached continuation page, I hereby declare that:

My residence, post office address and citizenship are as stated next to my name.

I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled PROCESS FOR FABRICATING FILMS OF UNIFORM PROPERTIES ON SEMICONDUCTOR DEVICES, the specification of which (check one):

		was amended on,		
B 10	and v	as amended under PCT Article 19 on	 '	
I hereby state that I have reviewed and	I understand the contents of the above-identified	specification, including the claims, as amend	ded by any an	rendment
referred to almove.				
I acknowledge the duty to disclose to t	he U.S. Patent and Trademark Office all inform	ation known to me to be material to the esta-	عدكم بيوالطموم	
matter claimed in this application, as "ma	teriality" is defined in Title 37, Code of Federal	Regulations § 1.56.	meomity of m	e subject
certificate or § 365(a) of any PCT interna attached continuation page and have also i	under Title 35. United States Code, § 119 (a)-(o tional application(s) designating at least one cou- dentified below and on any attached continuation nating at least one country other than the United i.	otry other than the United States of America page any foreign application for patent or i	listed helow (end on e
Prior foreign/PCT application(s):				
			Priority C	laimed '
(number)	(country)	(day/month/year filed)	Yes	No
(number)	(country)	(day/month/year filed)	Yes	No
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Inventor's signature

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or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any

Post Office Address: 1919 Nez Perce Street, Boise, ID 83705

Full name of first joint inventor: Garry Anthony Mercaldi

patent issued thereon.

DECLARATION FOR PATENT APPLICATI

(continuation page)

Invention title: PROCESS FOR FABRICATING FILMS OF UNIFORM PROPERTIES ON SEMICONDUCTOR DEVICES

Inventor name(s) appearing on first declaration page: Garry Anthony Mercaldi

Additional original, first and joint inventor(x):

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